

Photocathode Physics for Photoinjectors (P3) 2016:

Synthesis and x-ray characterization of Bi-alkali antimonide photocathodes

Presented by

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Surface roughness



Quantum Efficacy



Sequential growth



Yo-Yo growth



K/Cs Co-deposition

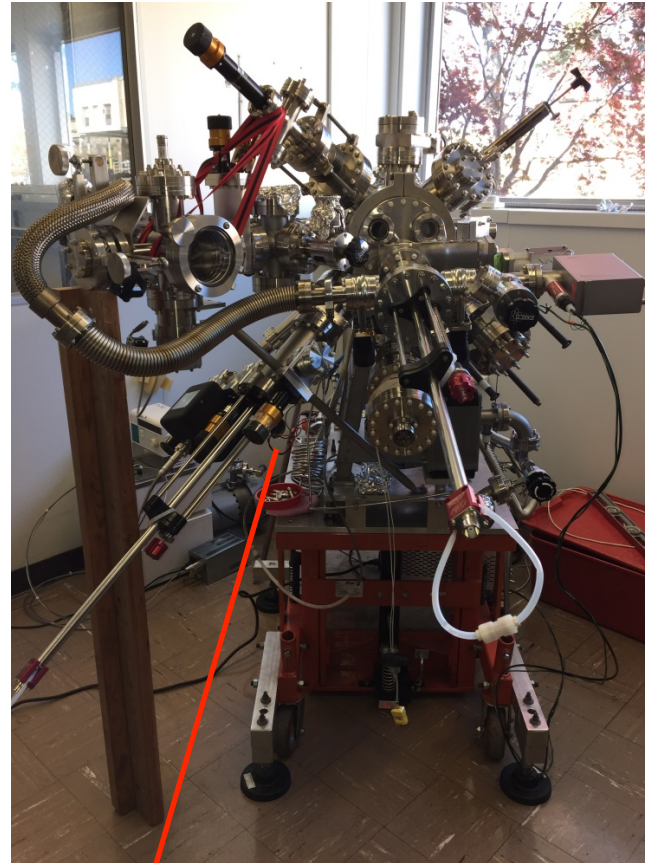
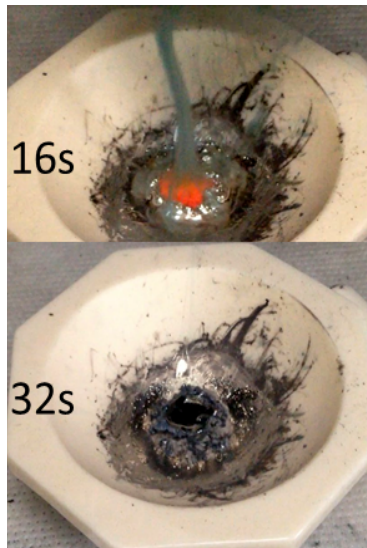


K_2CsSb sputter



Triple evaporation

Sputter growth of Bi-alkali photocathode



K_2CsSb
sputter gun



Before



Sputtering

Sputter target and sputter gun was product of RMD. Inc. Photos of sputter target prep are contributed by H. Bhandari

Sputter growth of Bi-alkali photocathode

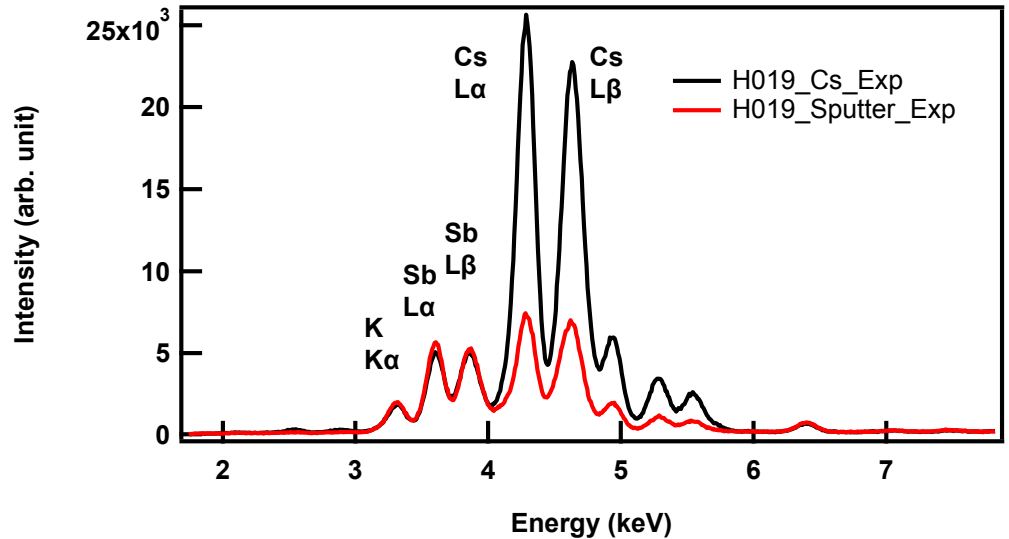
Si / MgO substrate @ 90C



K₂CsSb sputter



Cs deposition
@ 60 ~ 70 C

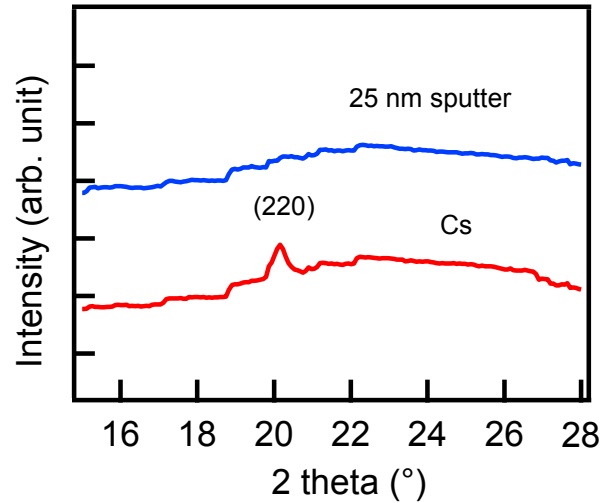


layer	K (+/-0.1)	Sb (+/-0.05)	Cs (+/-0.05)	K/Cs
K ₂ CsSb sputter	0.83	1.00	0.41	2.02
Cs	0.84	1.00	1.75	0.48

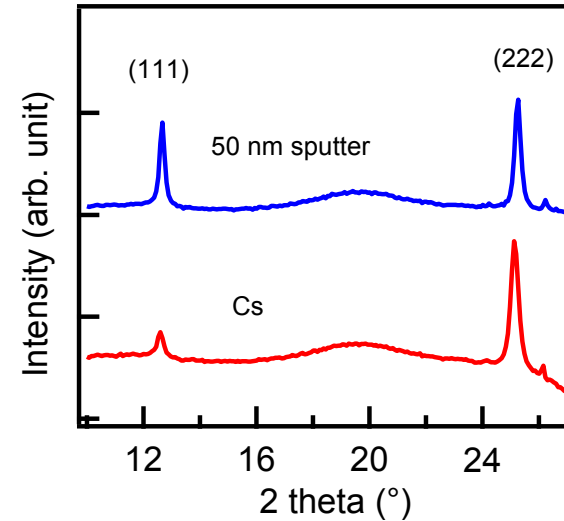
- Sputtered layers are deficient in Alkali
- Is maintaining a good K/Cs ratio

Structure of sputtered cathodes

- 25 nm sputtered layer + Cs



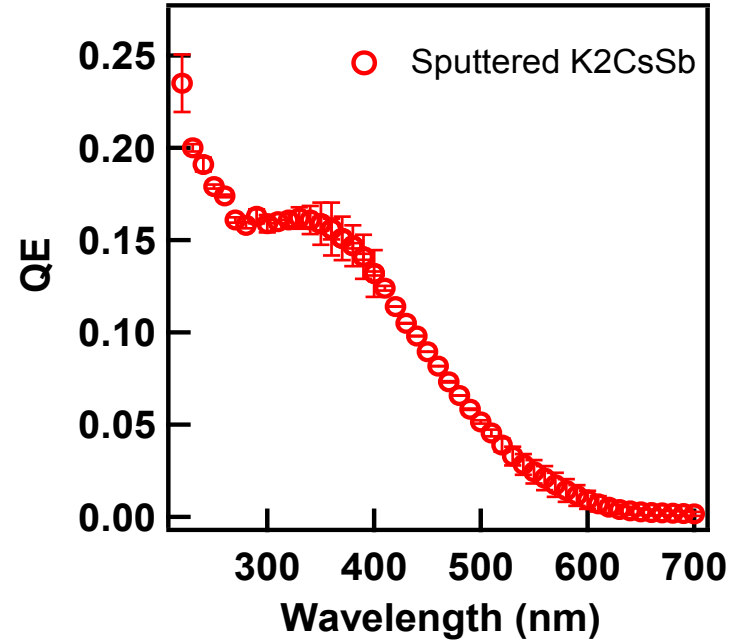
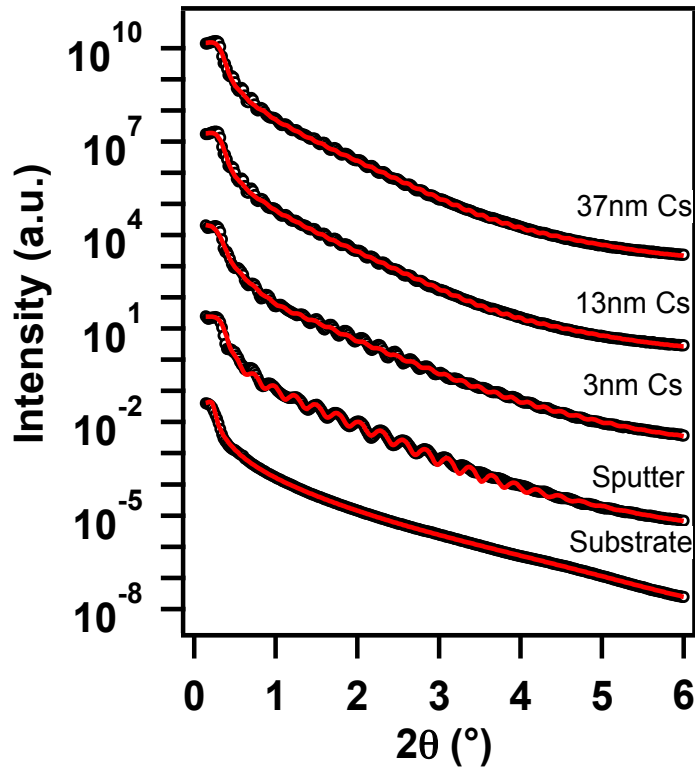
- 50 nm sputtered layer + Cs



HKL	Theo.K ₂ CsSb	Theo.KCs ₂ Sb	Sample1 (after Cs)	Sample2 (sputter)	Sample2 (after Cs)
111	12.67			12.67	12.6
220	20.76	20.12	20.16		
222	25.46	24.71		25.27	25.12

- Sputtered layer is initially amorphous and will weakly crystallize as film thickness increase.
- Adding Cs will increase crystallinity, might change cathode from K₂CsSb to KCs₂Sb

Surface roughness & QE of sputtered photocathodes

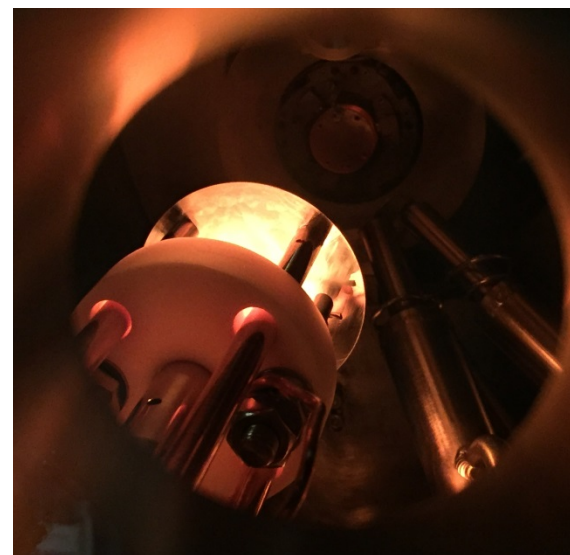
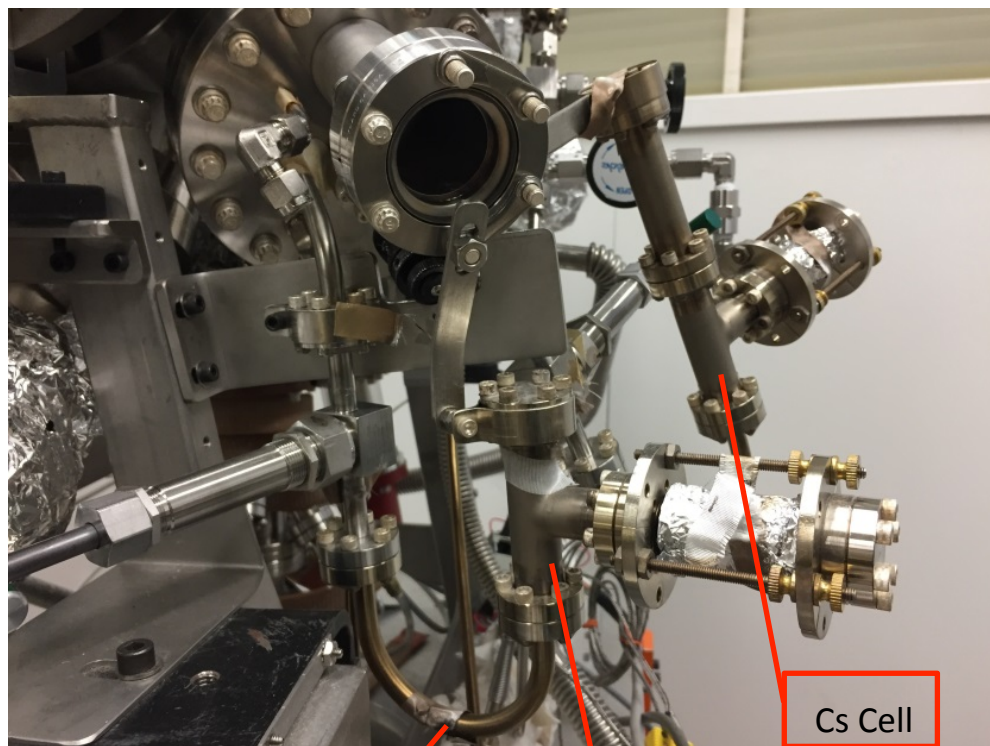


	Thickness (Å)	Roughness (Å)
Substrate (Si)		3.75
SiO ₂	10.24	3.27
Sputtered layer	234.2	5.17
1 st Cs	249.5	4.91
2 nd Cs	341.3	4.94
3 rd Cs	416.0	5.67

- Peak QE > 20%
- Green QE: 4.3%

Triple evaporation cathode growth with effusion cell

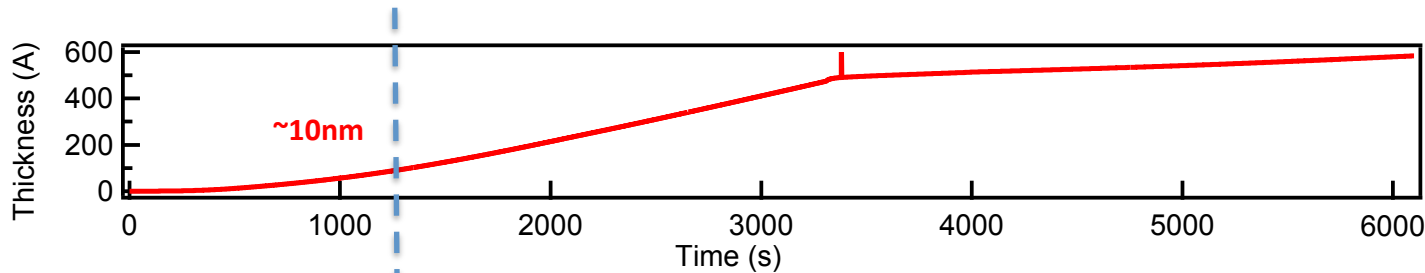
Simultaneously evaporate from Sb evaporator and K,Cs effusion cells



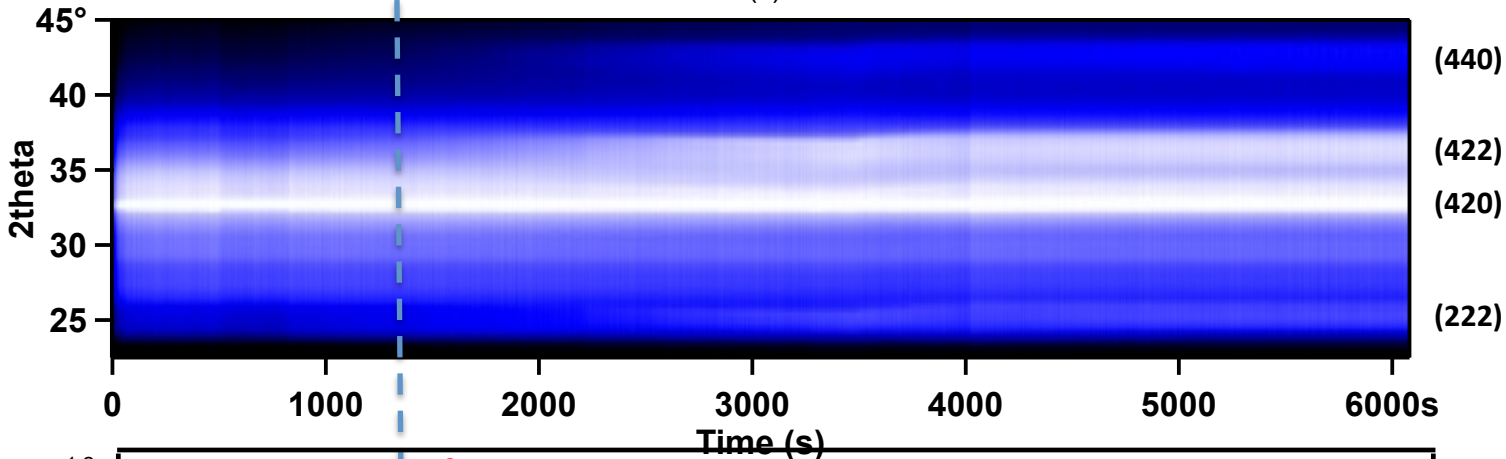
In situ, In operado XRR, XRF, XRD & Quantum efficiency (QE) measurement

- Growth rate are controlled by J tube temperature, valve and shutter

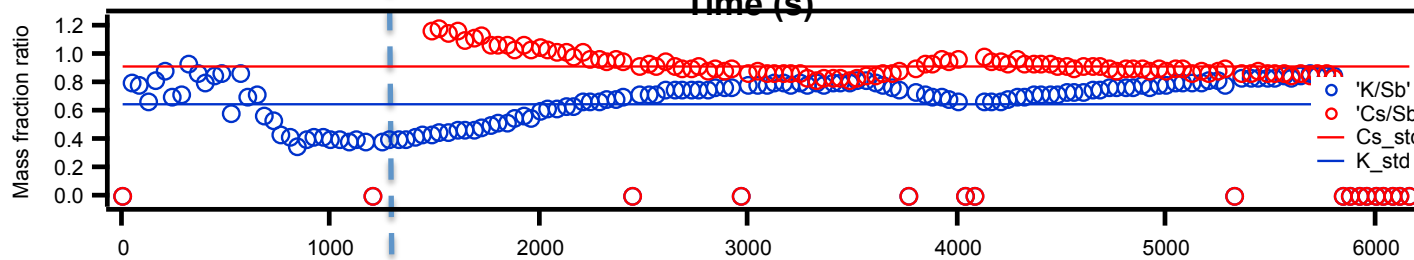
Thickness



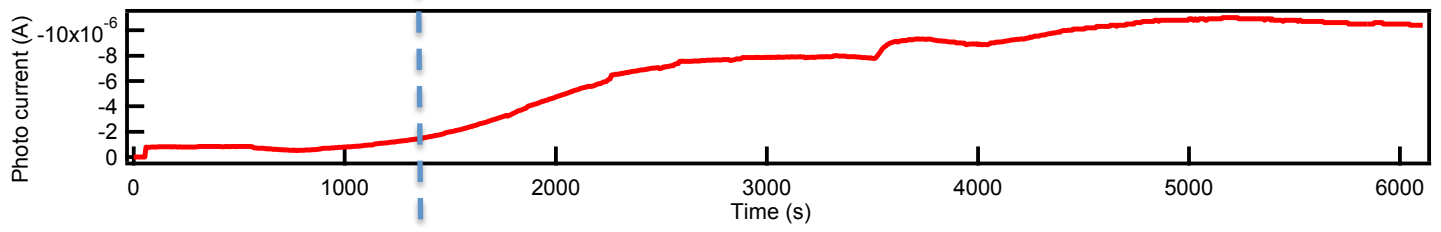
Real time XRD



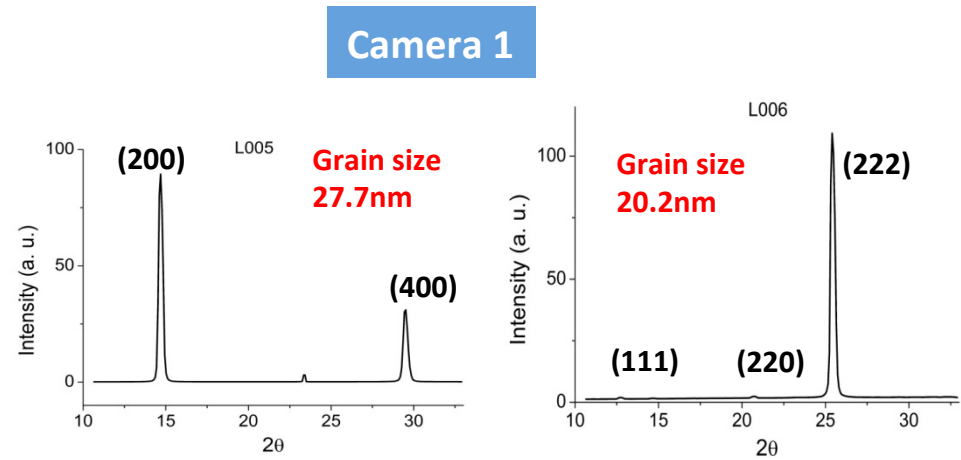
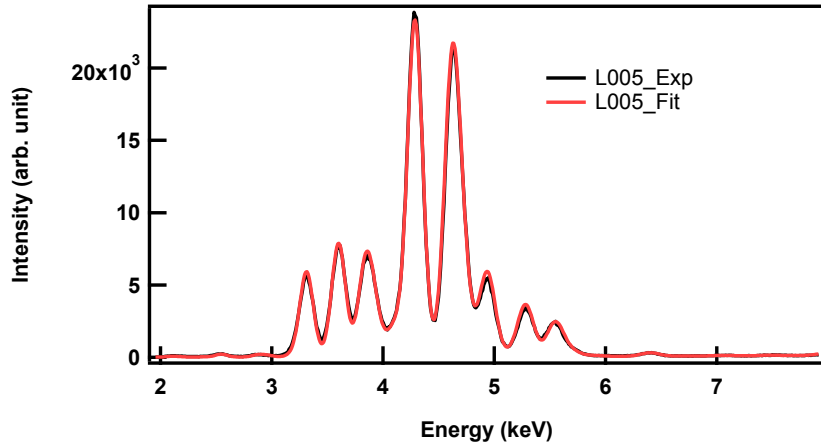
Real time Fluorescence



QE



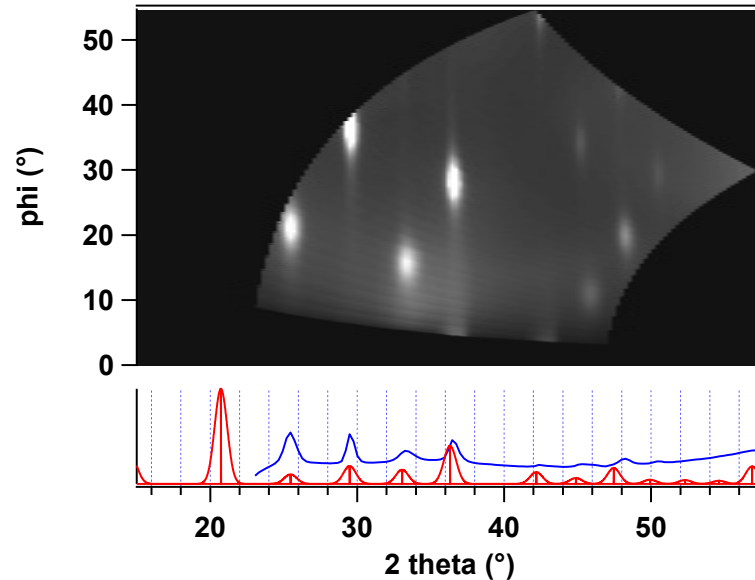
Stoichiometry & Structural Analysis



Camera 2

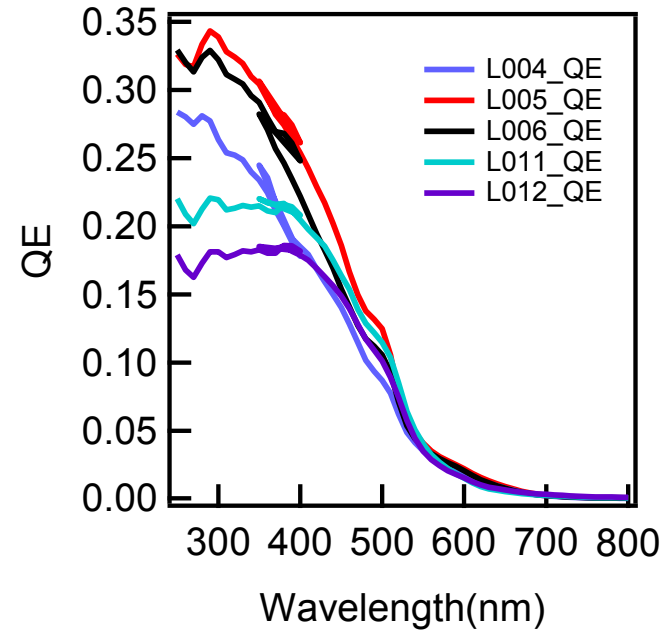
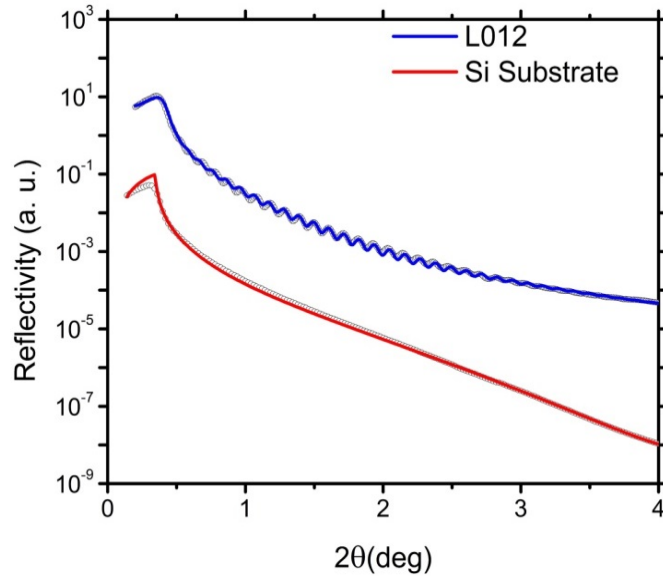
	K	Sb	Cs
L004 Si	2.50	1.00	1.16
L005 Si	2.37	1.00	0.91
L006 Si	2.21	1.00	0.95
L011 Si	2.07	1.00	0.94
L012 MgO	1.98	1.00	0.88

Good K/Cs/Sb ratio!



Highly textured K_2CsSb phase!

Surface roughness & QE



	QE@532nm (%)	Roughness(A)	Thickness (A)	Grain size (A)
L004 Si	4.9	3.5	234	155
L005 Si	5.8	11.5	815.3	277
L006 Si	5.4	13.8	757.5	202
L011 Si (Higher substrate T)	6.4	79.0	905.2	208
L012 MgO	5.7	8.6	566.4	193

Summary

- Both sputter and effusion cell are very promising method in cathode growth.
- Sputtering will create amorphous cathodes with the best roughness and high QE. This method is highly reproducible and can grow over large area.
- Effusion cell is an endless source for growth. Can achieve growing very thick cathodes.
- Cathodes grown by triple evaporation using effusion cell will create large grains that reduces grain boundary scattering. It will have very smooth surface and higher green QE.

Thanks for your attention!

- Thanks to Z. Ding, J. Sinsheimer, S. Schubert, J. Kuhn, H. Bhandari, M. Marshall, V. Nagarkar, E. M. Muller, J. Xie, J. Walsh, K. Attenkofer, H. Padmore, H. Frisch, J. Smedley
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